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TRSF23243CDGG

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TRSF23243 3-V TO 5.5-V DUAL RS-232 PORT

SLLS855-AUGUST 2007

FEATURES

- Single-Chip and Single-Supply Interface for Two IBM PC/AT Serial Ports
- Meets or Exceeds the Requirements of TIA/EIA-232-F and ITU v.28 Standards
- Operates With 3-V to 5.5-V V_{CC} Supply
- Always-Active Noninverting Receiver Output (ROUT2) Per Port
- Operates Up To 250 kbit/s
- Low Standby Current . . . 1 μA Typical
- External Capacitors . . . 4 × 0.22 μF
- Accepts 5-V Logic Input With 3.3-V Supply
- Allows for Flexible Power Down of Either Serial Port
- Serial-Mouse Driveability
- RS-232 Bus-Pin ESD Protection Exceeds ±15 kV Using Human-Body Model (HBM)

APPLICATIONS

- Battery-Powered Systems
- Notebooks
- Laptops
- Palmtop PCs
- Hand-Held Equipment

(TOP VIEW) RIN5A II 1 48 ROUT5A RIN4A 🛮 2 47 NOUT4A RIN3A 🛚 3 46 ROUT3A RIN2A 4 45 ROUT2A RIN1A [] 5 44 l rout1a INVA [] 6 43 ROUT2A DOUT3A [] 7 42 ∏ DIN3A DOUT2A [] 8 41 DIN2A DOUT1A 9 40 DIN1A FORCEOFFA [] 10 39 TFORCEON 38 N-C2- 11 37 V+ C2+ 1 12 GND [] 13 36 C1+ V_{CC} [] 14 35 ∏ C1-FORCEOFFB [] 15 34 ¶ GND DOUT1B [] 16 33 N DIN1B DOUT2B 17 32 DIN2B DOUT3B 18 31 DIN3B INVB 19 30 ROUT2B RIN1B [20 29 ROUT1B RIN2B [] 21 28 ROUT2B RIN3B [] 22 27 ROUT3B RIN4B [23 26 ROUT4B RIN5B [] 24 25 ROUT5B

DGG OR DL PACKAGE

DESCRIPTION/ORDERING INFORMATION

The TRSF23243 consists of two ports, each containing three line drivers and five line receivers, and a dual charge-pump circuit with ± 15 -kV ESD protection pin to pin (serial-port connection pins, including GND). This device meets the requirements of TIA/EIA-232-F and provides the electrical interface between an asynchronous communication controller and the serial-port connector. This combination of drivers and receivers matches that needed for two typical serial ports used in an IBM PC/AT, or compatible. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. In addition, this device includes an always-active noninverting output (ROUT2) per port, which allows applications using the ring indicator to transmit data while the device is powered down. The device operates at data signaling rates up to 250 kbit/s and a maximum of 30-V/ μ s driver output slew-rate.

ORDERING INFORMATION

T _A	PAC	(AGE ⁽¹⁾⁽²⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	SSOP – DL	Tube of 25	TRSF23243CDL	- TRSF23243C
	330P – DL	Reel of 1000	TRSF23243CDLR	- TRSF23243C
	TSSOP - DGG	Reel of 2000	TRSF23243CDGGR	TRSF23243C
	SSOP – DL	Tube of 25	TRSF23243IDL	TRSF23243I
–40°C to 85°C	330P – DL	Reel of 1000	TRSF23243IDLR	1855232431
	TSSOP - DGG	Reel of 2000	TRSF23243IDGGR	TRSF23243I

- (1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.
- (2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.



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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

Flexible control options for power management are available when either or both serial ports are inactive. The auto-powerdown feature functions when FORCEON is low and $\overline{\text{FORCEOFF}}$ is high. During this mode of operation, if the device does not sense a valid RS-232 signal, the driver outputs of its respective port are disabled. If $\overline{\text{FORCEOFF}}$ is set low, both drivers and receivers (except $\overline{\text{ROUT2}}$) are shut off, and the supply current is reduced to 1 μ A. Disconnecting the serial port or turning off the peripheral drivers causes the auto-powerdown condition to occur.

Auto-powerdown can be disabled when FORCEON and $\overline{\text{FORCEOFF}}$ are high and should be done when driving a serial mouse. With auto-powerdown enabled, the RS-232 port is activated automatically when a valid signal is applied to any respective receiver input. The $\overline{\text{INV}}$ output is used to notify the user if an RS-232 signal is present at any receiver input. $\overline{\text{INV}}$ is high (valid data) if any receiver input voltage is greater than 2.7 V or less than -2.7 V or has been between -0.3 V and 0.3 V for less than 30 μ s. Refer to Figure 5 for receiver input levels.

FUNCTION TABLES

Each Driver⁽¹⁾ (Each Port)

	INPUTS			OUTPUT	
DIN	FORCEON	FORCEOFF	VALID RIN RS-232 LEVEL	DOUT	DRIVER STATUS
Х	Х	L	Х	Z	Powered off
L	Н	Н	X	Н	Normal operation with
Н	Н	Н	X	L	auto-powerdown disabled
L	L	Н	Yes	Н	Normal operation with
Н	L	Н	Yes	L	auto-powerdown enabled
L	L	Н	No	Z	Powered off by
Н	L	Н	No	Z	auto-powerdown feature

(1) H = high level, L = low level, X = irrelevant, Z = high impedance

Each Receiver⁽¹⁾ (Each Port)

		INPUTS		OUTF	PUTS	
RIN2	RIN1, RIN3–RIN5	FORCEOFF	VALID RIN RS-232 LEVEL	ROUT2	ROUT	RECEIVER STATUS
L	Х	L	X	L	Z	Powered off while
Н	X	L	X	Н	Z	ROUT2 is active
L	L	Н	Yes	L	Н	
L	Н	Н	Yes	L	L	Normal operation with
Н	L	Н	Yes	Н	Н	auto-powerdown
Н	Н	Н	Yes	Н	L	disabled/enabled
Open	Open	Н	No	L	Н	

⁽¹⁾ H = high level, L = low level, X = irrelevant,

Z = high impedance (off),

Open = input disconnected or connected driver off

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29 ROUT1B

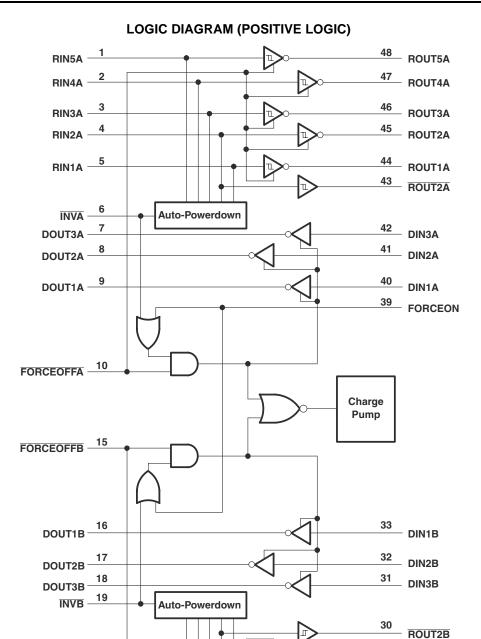
28 ROUT2B

26 ROUT4B

25 ROUT5B

- ROUT3B

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20

21

22

24

RIN1B -

RIN2B

RIN3B

RIN4B

RIN5B -

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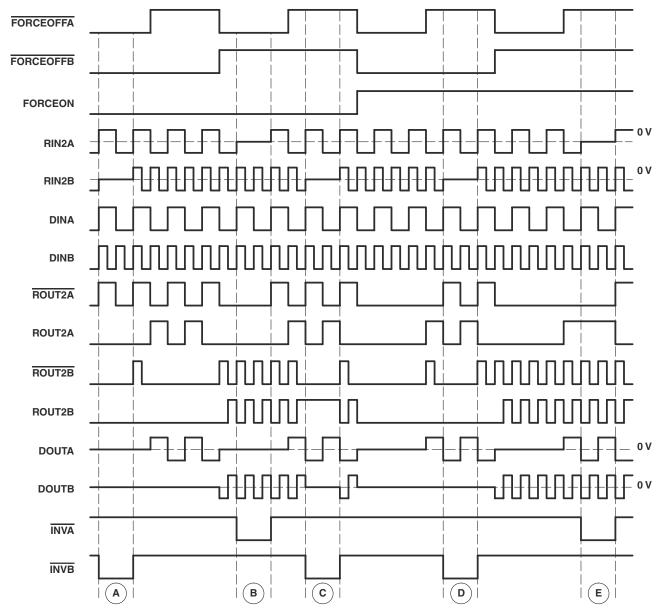
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Timing

Figure 1 shows how the two independent serial ports can be enabled or disabled. As shown by the logic states, depending on the FORCEOFF, FORCEON, and receiver input levels, either port can be powered down. Intermediate receiver input levels indicate a 0-V input. Also, it is assumed a pulldown resistor to ground is used for the receiver outputs. The INV pin goes low when its respective receiver input does not supply a valid RS-232 level. For simplicity, voltage levels, timing differences, and input/output edge rates are not shown.



- A. Ports A and B manually powered off.
- B. Port A manually powered off, port B in normal operation with auto-powerdown enabled.
- C. Port B powered off by auto-powerdown, port A in normal operation with auto-powerdown enabled.
- D. Port A in normal operation with auto-powerdown disabled, port B manually powered off.
- E. Ports A and B in normal operation with auto-powerdown disabled

Figure 1. Timing Diagram

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Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage range ⁽²⁾		-0.3	6	V
V+	Positive-output supply voltage range ⁽²⁾		-0.3	7	V
V-	Negative-output supply voltage range ⁽²⁾		0.3	-7	V
V+ - V-	Supply voltage difference ⁽²⁾			13	V
V	Input voltage range	Driver (FORCEOFF, FORCEON)	-0.3	6	
V _I		Receiver	-25	25	V
.,	Output valtage range	Driver	-13.2	13.2	V
Vo	Output voltage range	Receiver (INV)	-0.3	V _{CC} + 0.3	V
0	Dealer - 4 1 : (3)(4)	DGG package		70	0000
θ_{JA}	Package thermal impedance (3)(4)	DL package		63	°C/W
TJ	Operating virtual junction temperature			150	°C
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Recommended Operating Conditions⁽¹⁾

See Figure 7

				MIN	NOM	MAX	UNIT
	Cumply voltoge		V _{CC} = 3.3 V	3	3.3	3.6	V
	Supply voltage		V _{CC} = 5 V	4.5	5	5.5	V
\/	Driver and control high-level input voltage	DIN, FORCEOFF, FORCEON	V _{CC} = 3.3 V	2			V
V _{IH}		DIN, FORGEOFF, FORGEON	V _{CC} = 5 V	2.4			V
V _{IL}	Driver and control low-level input voltage	DIN, FORCEOFF, FORCEON				0.8	٧
. /	Driver and control input voltage	DIN, FORCEOFF, FORCEON		0		5.5	V
VI	Receiver input voltage			-25		25	V
_	Operating free-air temperature		TRSF23243C	0		70	00
T _A			TRSF23243I	-40		85	°C

⁽¹⁾ Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V \pm 0.5 V.

Electrical Characteristics(1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 7)

	PAF	RAMETER	TEST CONDITIONS	MIN	TYP ⁽²⁾	MAX	UNIT
II	Input leakage current	FORCEOFF, FORCEON			±0.01	±1	μΑ
		Auto-powerdown disabled	No load, FORCEOFF and FORCEON at V _{CC}		0.6	2	mA
I _{CC}	Supply current	Powered off	No load, FORCEOFF at GND		1	20	
	$(T_A = 25^{\circ}C)$	Auto-powerdown enabled	No load, FORCEOFF at V _{CC} , FORCEON at GND, All RIN are open or grounded		1	20	μΑ

⁽¹⁾ Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V \pm 0.5 V.

²⁾ All voltages are with respect to network GND.

⁽³⁾ Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.

⁽²⁾ All typical values are at $V_{CC} = 3.3 \text{ V}$ or $V_{CC} = 5 \text{ V}$, and $T_A = 25^{\circ}\text{C}$.



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DRIVER SECTION

Electrical Characteristics(1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 7)

	PARAMETER	TEST CONDITIONS	MIN	TYP ⁽²⁾	MAX	UNIT
V _{OH}	High-level output voltage	All DOUT at $R_L = 3 \text{ k}\Omega$ to GND	5	5.4		٧
V _{OL}	Low-level output voltage	All DOUT at $R_L = 3 \text{ k}\Omega$ to GND	-5	-5.4		V
Vo	Output voltage (mouse driveability)	DIN1 = DIN2 = GND, DIN3 = V_{CC} , 3-kΩ to GND at DOUT3, DOUT1 = DOUT2 = -2.5 mA	±5			V
I _{IH}	High-level input current	$V_I = V_{CC}$		±0.01	±1	μA
I _{IL}	Low-level input current	V _I at GND		±0.01	±1	μA
Ios	Short-circuit output current (3)	$V_{CC} = 3.6 \text{ V}$ $V_{O} = 0 \text{ V}$ $V_{CC} = 5.5 \text{ V}$ $V_{O} = 0 \text{ V}$		±35	±60	mA
ro	Output resistance	V_{CC} , V+, and V- = 0 V, $V_{O} = \pm 2 \text{ V}$	300	10M		Ω
I _{OZ}	Output leakage current	FORCEOFF = GND, $\frac{V_{O} = \pm 12 \text{ V}, V_{CC} = 3 \text{ V to } 3.6 \text{ V}}{V_{O} = \pm 10 \text{ V}, V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}}$			±25 ±25	μΑ

Switching Characteristics⁽¹⁾

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 7)

	PARAMETER	٦	TEST CONDITIONS	MIN	TYP ⁽²⁾ MAX	UNIT
	Maximum data rate	$R_L = 3 \text{ k}\Omega,$ One DOUT switching	C _L = 1000 pF, See Figure 2	250		kbit/s
t _{sk(p)}	Pulse skew ⁽³⁾	C _L = 150 pF to 2500 pF,	$R_L = 3 \text{ k}\Omega \text{ to } 7 \text{ k}\Omega, \text{ See Figure 2}$		100	ns
	Slew rate,	$V_{CC} = 3.3 \text{ V},$	C _L = 150 pF to 1000 pF	6	30	
SR(tr)	transition region (see Figure 2)	$R_L = 3 \text{ k}\Omega \text{ to } 7 \text{ k}\Omega$	C _L = 150 pF to 2500 pF	4	30	V/µs

Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V \pm 0.5 V. All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C. Pulse skew is defined as $|t_{PLH}| - t_{PHL}|$ of each channel of the same device.

Test conditions are C1–C4 = 0.1 μ F at V_{CC} = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V \pm 0.5 V. All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C. Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

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RECEIVER SECTION

Electrical Characteristics⁽¹⁾

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 7)

	PARAMETER	TEST CONDITIONS	MIN	TYP ⁽²⁾	MAX	UNIT
V_{OH}	High-level output voltage	$I_{OH} = -1 \text{ mA}$	V _{CC} - 0.6	$V_{CC} - 0.1$		V
V_{OL}	Low-level output voltage	I _{OL} = 1.6 mA			0.4	V
\/	Desitive going input threshold voltage	V _{CC} = 3.3 V		1.6	2.4	V
V _{IT+}	Positive-going input threshold voltage	V _{CC} = 5 V		1.9	2.4	V
\/	Negative going input threshold voltage	V _{CC} = 3.3 V	0.6	1.1		V
V_{IT-}	Negative-going input threshold voltage	V _{CC} = 5 V	0.8	1.4		V
V _{hys}	Input hysteresis (V _{IT+} - V _{IT-})			0.5		V
I _{OZ}	Output leakage current (except ROUT2B)	FORCEOFF = 0 V		±0.05	±10	μΑ
r _l	Input resistance	$V_{I} = \pm 3 \text{ V to } \pm 25 \text{ V}$	3	5	7	kΩ

⁽¹⁾ Test conditions are C1–C4 = 0.22 μ F at V_{CC} = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V \pm 0.5 V. (2) All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.

Switching Characteristics⁽¹⁾

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 3)

	PARAMETER	TEST CONDITIONS			UNIT
t _{PLH}	Propagation delay time, low- to high-level output	C _L = 150 pF,	See Figure 4	150	ns
t _{PHL}	Propagation delay time, high- to low-level output	C _L = 150 pF,	See Figure 4	150	ns
t _{en}	Output enable time	C _L = 150 pF, See Figure 5	$R_L = 3 \text{ k}\Omega,$	200	ns
t _{dis}	Output disable time	C _L = 150 pF, See Figure 5	$R_L = 3 \text{ k}\Omega,$	200	ns
t _{sk(p)}	Pulse skew ⁽³⁾	See Figure 4		50	ns

Test conditions are C1–C4 = 0.22 μ F at V_{CC} = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at V_{CC} = 5 V \pm 0.5 V.

 ⁽²⁾ All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.
 (3) Pulse skew is defined as |t_{PLH} - t_{PHL}| of each channel of the same device.

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AUTO-POWERDOWN SECTION

Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 6)

	PARAMETER	TEST (CONDITIONS	MIN	MAX	UNIT
V _{T+(valid)}	Receiver input threshold for INV high-level output voltage	FORCEON = GND,	FORCEOFF = V _{CC}		2.7	V
V _{T(valid)}	Receiver input threshold for INV high-level output voltage	FORCEON = GND,	FORCEOFF = V _{CC}	-2.7		V
V _{T(invalid)}	Receiver input threshold for INV low-level output voltage	FORCEON = GND,	FORCEOFF = V _{CC}	-0.3	0.3	V
V _{OH}	ĪNV high-level output voltage	I _{OH} = -1 mA, FORCEOFF = V _{CC}	FORCEON = GND,	V _{CC} - 0.6		V
V _{OL}	ĪN∇ low-level output voltage	I _{OL} = 1.6 mA, FORCEOFF = V _{CC}	FORCEON = GND,		0.4	V

Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 6)

	PARAMETER	TYP ⁽¹⁾	UNIT
t _{valid}	Propagation delay time, low- to high-level output	1	μs
t _{invalid}	Propagation delay time, high- to low-level output	30	μs
t _{en}	Supply enable time	100	μs

⁽¹⁾ All typical values are at V_{CC} = 3.3 V or V_{CC} = 5 V, and T_A = 25°C.

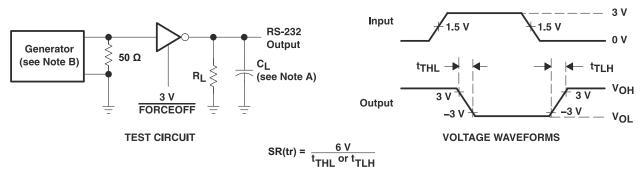
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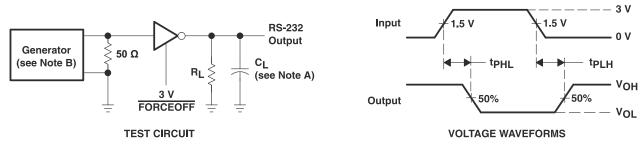
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PARAMETER MEASUREMENT INFORMATION



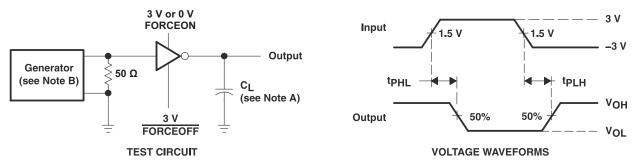
- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR = 250 kbits/s, Z_O = 50 Ω , 50% duty cycle, $t_r \le$ 10 ns, $t_f \le$ 10 ns.

Figure 2. Driver Slew Rate



- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR = 250 kbits/s, Z_O = 50 Ω , 50% duty cycle, $t_f \le$ 10 ns, $t_f \le$ 10 ns.

Figure 3. Driver Pulse Skew



- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR = 250 kbits/s, Z_O = 50 Ω , 50% duty cycle, $t_r \le$ 10 ns, $t_f \le$ 10 ns.

Figure 4. Receiver Propagation Delay Times

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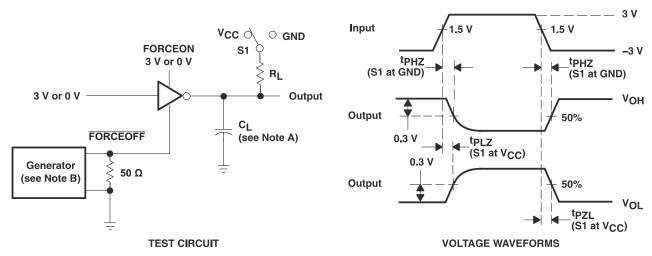
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PARAMETER MEASUREMENT INFORMATION (continued)



- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR = 250 kbits/s, $Z_O = 50 \Omega$, 50% duty cycle, $t_r \le 10$ ns, $t_f \le 10$ ns
- C. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- D. t_{PZL} and t_{PZH} are the same as t_{en} .

Figure 5. Receiver Enable and Disable Times



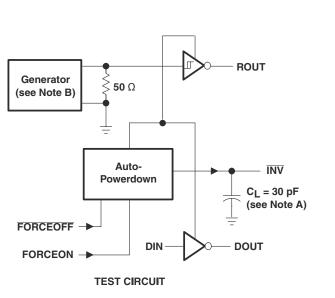
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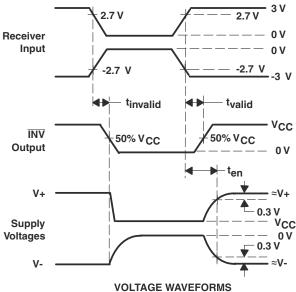
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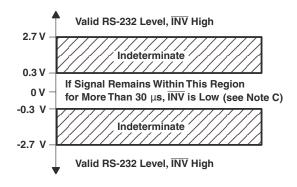
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PARAMETER MEASUREMENT INFORMATION (continued)







- A. C_L includes probe and jig capacitance.
- B. The pulse generator has the following characteristics: PRR = 250 kbits/s, $Z_O = 50 \Omega$, 50% duty cycle, $t_r \le 10$ ns, $t_f \le 10$ ns

Figure 6. INV Propagation Delay Times and Supply Enabling Times

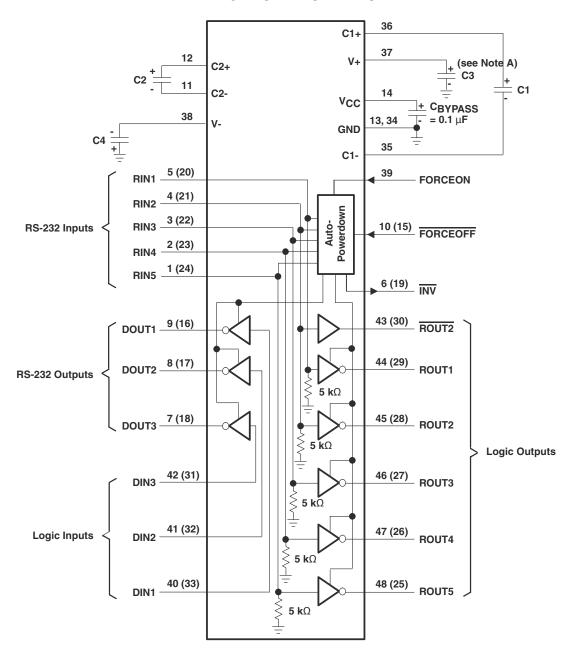
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APPLICATION INFORMATION



V_{CC} vs CAPACITOR VALUES

VCC	C1	C2, C3, and C4			
$\begin{array}{c} 3.3 \ V \ \pm \ 0.3 \ V \\ 5 \ V \ \pm \ 0.5 \ V \\ 3 \ V \ to \ 5.5 \ V \end{array}$	0.22 μF 0.047 μF 0.22 μF	0.22 μF 0.33 μF 1 μF			

- A. C3 can be connected to V_{CC} or GND.
- B. Resistor values shown are nominal.
- C. Numbers in parentheses are for B section.

Figure 7. Typical Operating Circuit and Capacitor Values



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PACKAGE OPTION ADDENDUM

10-Jun-2014

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
TRSF23243CDGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	TRSF23243C	Samples
TRSF23243CDLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	TRSF23243C	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width

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Addendum-Page 1



Datasheet of TRSF23243CDGG - IC DUAL RS232 PORT 48TSSOP

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PACKAGE OPTION ADDENDUM

10-Jun-2014

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

Addendum-Page 2

Datasheet of TRSF23243CDGG - IC DUAL RS232 PORT 48TSSOP

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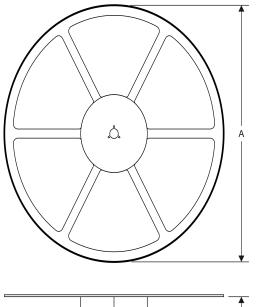


PACKAGE MATERIALS INFORMATION

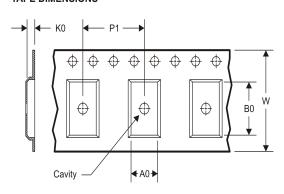
www.ti.com 14-Jul-2012

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



	A0	Dimension designed to accommodate the component width
	В0	Dimension designed to accommodate the component length
Γ	K0	Dimension designed to accommodate the component thickness
	W	Overall width of the carrier tape
Γ	P1	Pitch between successive cavity centers



TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TRSF23243CDGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
TRSF23243CDLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1



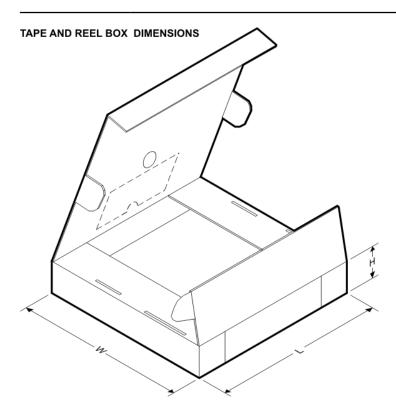
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*All dimensions are nominal

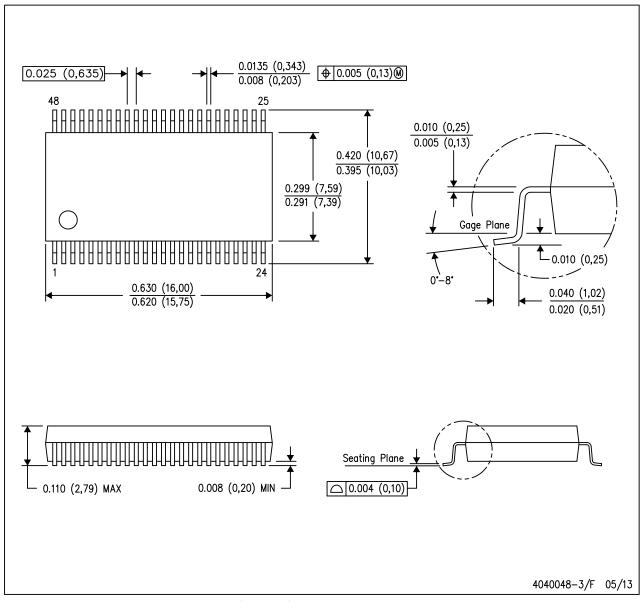
7 till dilliforioriorio di o rioriniriai								
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
TRSF23243CDGGR	TSSOP	DGG	48	2000	367.0	367.0	45.0	
TRSF23243CDLR	SSOP	DL	48	1000	367.0	367.0	55.0	



MECHANICAL DATA

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

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Datasheet of TRSF23243CDGG - IC DUAL RS232 PORT 48TSSOP

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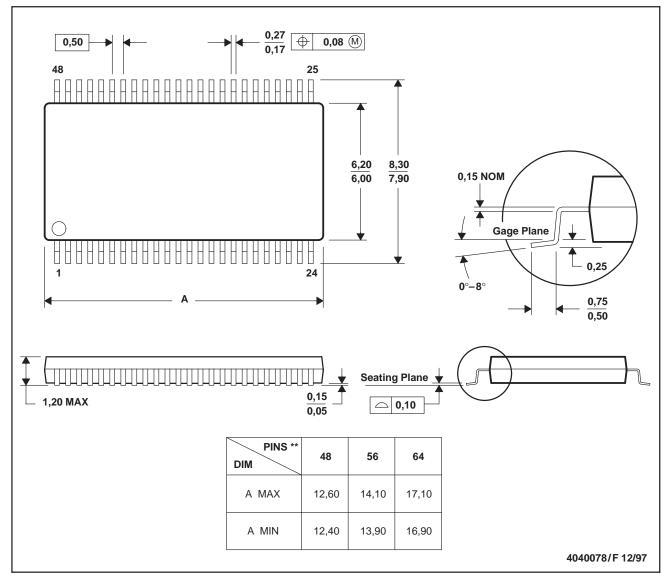
MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153





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